Docket No.: JCLA14502 01 - 10	-2005
·	. S. Department of Commerce at and Trademark Office
1029	16485
To the Honorable Assistant Commissioner for Patents: Please record the attached Original documents or copy thereof.	
Name of conveying party(ies) with the execution date:	2. Name/address of receiving Party(ies)
WEN-FANG LEE, December 01, 2004	UNITED MICROELECTRONICS CORP.
DAVE HSU, December 01, 2004	
ASAM LIN, December 01, 2004	NO. 3, LI-HSIN RD. II, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU, TAIWAN, R.O.C.
3. Nature of conveyance:	
x Assignment Security Agreement	
Merger Change of Name	
Reassignment Other	Add'1 names of receiving parties Attached? X No
4. Application number(s) or patent number(s):	
If this document is being file together with a new application, the execution date of the application is <u>December 01, 2004</u> .	
A. Patent Application No. (s)	B. Patent No.(s)
Additional number attached?	Yes x No
5. Name and address of party to whom	Total No. of applications and patents involved:
correspondence concerning document should be mailed:	involved.
Should be mailed.	ONE (1) 7. Total fee(37CFR§3.41): \$40.00
J. C. Patents	x Enclosed
4 Venture, Suite 250	x Charge to Acct. No. 50-0710
Irvine, CA 92618 (949) 660-0761	(Order No. JCLA14502) 8. Total number of pages, including
Atty Docket No.: JCLA14502	Cover sheet, attachments and Document 3.
DO NOT USE THIS SPACE	
9. Statement and Signature:	
To the best of my knowledge and belief, the forging information is true and Correct and any attached copy is a true copy of the original document.	

01/07/2005 DBYRME 01 FC:8021 PATENT PEEL : 046424 EPAN

REEL: 016124 FRAME: 0654

ASSIGNMENT

WHEREAS,

1

1. Wen-Fang Lee

2. Dave Hsu

3. Asam Lin

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD OF FABRICATING ONE-TIME PROGRAMMABLE READ ONLY MEMORY

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Microelectronics Corp. of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Men-Tiang Lee	December 1, 2004
Signature:	Date:
Sole or First Joint Inventor: Wen-Fang Lee	
Signature: Dave HSU	December 1, 2004
Signature:	Date:
Second Joint Inventor (if any): Dave Hsu	
Bam Len	December 1, 2004
Signature:	Date:

Third Joint Inventor (if any): Asam Lin

RECORDED: 12/23/2004